

Integrated Device Technology, Inc.

FAST CMOS OCTAL BIDIRECTIONAL TRANSCEIVERS

IDT54/74FCT245/A/C
IDT54/74FCT640/A/C
IDT54/74FCT645/A/C

FEATURES:

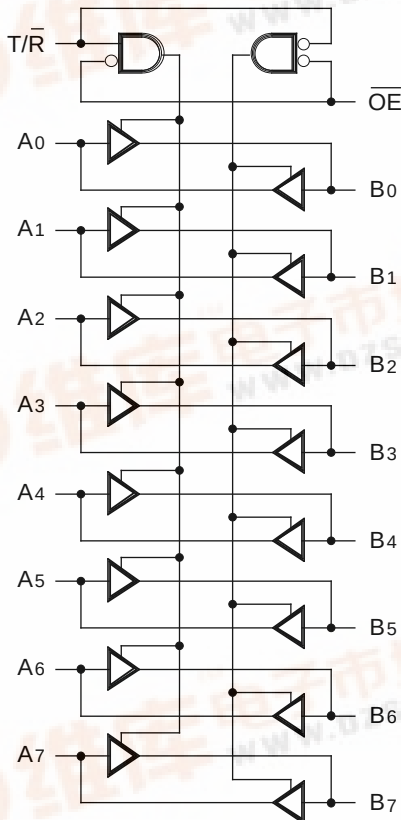
- IDT54/74FCT245/640/645 equivalent to FAST™ speed and drive
- **IDT54/74FCT245A/640A/645A 25% faster than FAST**
- **IDT54/74FCT245C/640C/645C 40% faster than FAST**
- TTL input and output level compatible
- CMOS output level compatible
- IOL = 64mA (commercial) and 48mA (military)
- Input current levels only 5μA max.
- CMOS power levels (2.5mW typical static)
- Direction control and over-riding 3-state control
- Product available in Radiation Tolerant and Radiation Enhanced versions
- Military product compliant to MIL-STD-883, Class B and DESC listed
- Meets or exceeds JEDEC Standard 18 specifications

DESCRIPTION:

The IDT octal bidirectional transceivers are built using an advanced dual metal CMOS technology. The IDT54/74FCT245/A/C, IDT54/74FCT640/A/C and IDT54/74FCT645/A/C are designed for asynchronous two-way communication between data buses. The transmit/receive ($T/\bar{R}$) input determines the direction of data flow through the bidirectional transceiver. Transmit (active HIGH) enables data from A ports to B ports, and receive (active LOW) from B ports to A ports. The output enable ($\overline{OE}$) input, when HIGH, disables both A and B ports by placing them in High-Z condition.

The IDT54/74FCT245/A/C and IDT54/74FCT645/A/C transceivers have non-inverting outputs. The IDT54/74FCT640/A/C has inverting outputs.

FUNCTIONAL BLOCK DIAGRAM

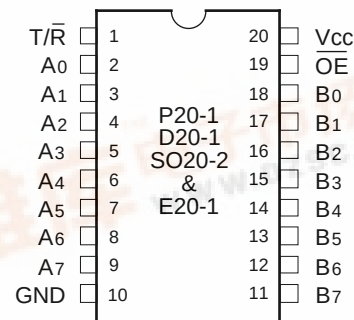


NOTES:

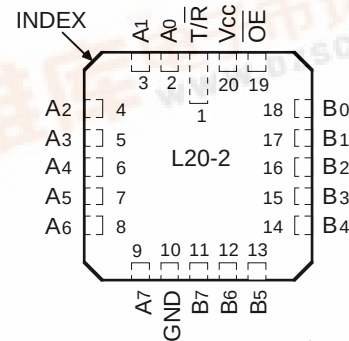
1. FCT245, 645 are noninverting options.
2. FCT640 is the inverting option.

2534 drw 02

PIN CONFIGURATIONS



DIP/SOIC/CERPACK
TOP VIEW



LCC
TOP VIEW

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PIN DESCRIPTION

Pin Names	Description
$\overline{OE}$	Output Enable Input (Active LOW)
$T/\overline{R}$	Transmit/Receive Input
A0–A7	Side A Inputs or 3-State Outputs
B0–B7	Side B Inputs or 3-State Outputs

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FUNCTION TABLE⁽²⁾

Inputs		Outputs
$\overline{OE}$	$T/\overline{R}$	
L	L	Bus B Data to Bus A ⁽¹⁾
L	H	Bus A Data to Bus B ⁽¹⁾
H	X	High Z State

NOTES:

- 640 is inverting from input to output.
- H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care

2534 tbl 06

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Rating	Commercial	Military	Unit
$V_{TERM}^{(2)}$	Terminal Voltage with Respect to GND	–0.5 to +7.0	–0.5 to +7.0	V
$V_{TERM}^{(3)}$	Terminal Voltage with Respect to GND	–0.5 to V_{CC}	–0.5 to V_{CC}	V
T_A	Operating Temperature	0 to +70	–55 to +125	°C
T_{BIAS}	Temperature Under Bias	–55 to +125	–65 to +135	°C
T_{STG}	Storage Temperature	–55 to +125	–65 to +150	°C
P_T	Power Dissipation	0.5	0.5	W
I_{OUT}	DC Output Current	120	120	mA

NOTES:

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- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability. No terminal voltage may exceed V_{CC} by +0.5V unless otherwise noted.
- Inputs and V_{CC} terminals.
- Outputs and I/O terminals.

CAPACITANCE ($T_A = +25^\circ\text{C}$, $f = 1.0\text{MHz}$)

Symbol	Parameter ⁽¹⁾	Conditions	Typ.	Max.	Unit
C_{IN}	Input Capacitance	$V_{IN} = 0V$	6	10	pF
$C_{I/O}$	I/O Capacitance	$V_{OUT} = 0V$	8	12	pF

NOTE:

- This parameter is measured at characterization but not tested.

2534 tbl 02

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: $V_{LC} = 0.2V$; $V_{HC} = V_{CC} - 0.2V$

Commercial: $T_A = 0^\circ C$ to $+70^\circ C$, $V_{CC} = 5.0V \pm 5\%$; Military: $T_A = -55^\circ C$ to $+125^\circ C$, $V_{CC} = 5.0V \pm 10\%$

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
V_{IH}	Input HIGH Level	Guaranteed Logic HIGH Level		2.0	—	—	V
V_{IL}	Input LOW Level	Guaranteed Logic LOW Level		—	—	0.8	V
I_{IH}	Input HIGH Current (Except I/O pins)	$V_{CC} = \text{Max}$	$V_I = V_{CC}$	—	—	5	μA
			$V_I = 2.7V$	—	—	5 ⁽⁴⁾	
I_{IL}	Input LOW Current (Except I/O pins)		$V_I = 0.5V$	—	—	-5 ⁽⁴⁾	
			$V_I = GND$	—	—	-5	
I_{IH}	Input HIGH Current (I/O pins only)	$V_{CC} = \text{Max}$	$V_I = V_{CC}$	—	—	15	μA
			$V_I = 2.7V$	—	—	15 ⁽⁴⁾	
I_{IL}	Input LOW Current (I/O pins only)		$V_I = 0.5V$	—	—	-15 ⁽⁴⁾	
			$V_I = GND$	—	—	-15	
V_{IK}	Clamp Diode Voltage	$V_{CC} = \text{Min.}$, $I_N = -18mA$		—	-0.7	-1.2	V
I_{OS}	Short Circuit Current	$V_{CC} = \text{Max.}$ ⁽³⁾ , $V_O = GND$		-60	-120	—	mA
V_{OH}	Output HIGH Voltage	$V_{CC} = 3V$, $V_{IN} = V_{LC}$ or V_{HC} , $I_{OH} = -32\mu A$		V_{HC}	V_{CC}	—	V
		$V_{CC} = \text{Min.}$ $V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -300\mu A$	V_{HC}	V_{CC}	—	
			$I_{OH} = -12mA \text{ MIL.}$	2.4	4.3	—	
			$I_{OH} = -15mA \text{ COM'L.}$	2.4	4.3	—	
V_{OL}	Output LOW Voltage (Port A and Port B)	$V_{CC} = 3V$, $V_{IN} = V_{LC}$ or V_{HC} , $I_{OL} = 300\mu A$		—	GND	V_{LC}	V
		$V_{CC} = \text{Min.}$ $V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 300\mu A$	—	GND	V_{LC} ⁽⁴⁾	
			$I_{OL} = 48mA \text{ MIL.}$	—	0.3	0.55	
			$I_{OL} = 64mA \text{ COM'L.}$	—	0.3	0.55	

NOTES:

- For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at $V_{CC} = 5.0V$, $+25^\circ C$ ambient and maximum loading.
- Not more than one output should be shorted at one time. Duration of the short circuit test should not exceed one second.
- This parameter is guaranteed but not tested.

POWER SUPPLY CHARACTERISTICS

$V_{LC} = 0.2V$; $V_{HC} = V_{CC} - 0.2V$

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
I _{CC}	Quiescent Power Supply Current	V _{CC} = Max. V _{IN} ≥ V _{HC} ; V _{IN} ≤ V _{LC}		—	0.5	1.5	mA
ΔI _{CC}	Quiescent Power Supply Current TTL Inputs HIGH	V _{CC} = Max. V _{IN} = 3.4V ⁽³⁾		—	0.5	2.0	mA
I _{CCD}	Dynamic Power Supply Current ⁽⁴⁾	V _{CC} = Max. Outputs Open $\overline{OE} = GND$ T/ $\overline{R}$ = GND or V _{CC} One Input Toggling 50% Duty Cycle	V _{IN} ≥ V _{HC} V _{IN} ≤ V _{LC}	—	0.15	0.25	mA/MHz
I _C	Total Power Supply Current ⁽⁶⁾	V _{CC} = Max. Outputs Open f _i = 10MHz 50% Duty Cycle T/ $\overline{R}$ = $\overline{OE} = GND$ One Bit Toggling	V _{IN} ≥ V _{HC} V _{IN} ≤ V _{LC} (FCT)	—	2.0	4.0	mA
			V _{IN} = 3.4V V _{IN} = GND	—	2.3	5.0	
		V _{CC} = Max. Outputs Open f _i = 2.5MHz	V _{IN} ≥ V _{HC} V _{IN} ≤ V _{LC} (FCT)	—	3.5	6.5 ⁽⁵⁾	
		50% Duty Cycle T/ $\overline{R}$ = $\overline{OE} = GND$ Eight Bits Toggling	V _{IN} = 3.4V V _{IN} = GND	—	5.5	14.5 ⁽⁵⁾	

NOTES:

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- For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V_{CC} = 5.0V, +25°C ambient.
- Per TTL driven input (V_{IN} = 3.4V); all other inputs at V_{CC} or GND.
- This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
- Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.
- I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}
 $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_{CP}/2 + f_i N_i)$
I_{CC} = Quiescent Current
ΔI_{CC} = Power Supply Current for a TTL High Input (V_{IN} = 3.4V)
D_H = Duty Cycle for TTL Inputs High
N_T = Number of TTL Inputs at D_H
I_{CCD} = Dynamic Current Caused by an Output Transition Pair (HLH or LHL)
f_{CP} = Clock Frequency for Register Devices (Zero for Non-Register Devices)
f_i = Input Frequency
N_i = Number of Inputs at f_i
All currents are in milliamps and all frequencies are in megahertz.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE FOR FCT245/A/C

Symbol	Parameter	Condition ⁽¹⁾	54/74FCT245				54/74FCT245A				54/74FCT245C				Unit
			Com'l.		Mil.		Com'l.		Mil.		Com'l.		Mil.		
			Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	
tPLH tPHL	Propagation Delay A to B, B to A	CL = 50 pF RL = 500Ω	1.5	7.0	1.5	7.5	1.5	4.6	1.5	4.9	1.5	4.1	1.5	4.5	ns
tpZH tpZL	Output Enable Time OE to A or B		1.5	9.5	1.5	10.0	1.5	6.2	1.5	6.5	1.5	5.8	1.5	6.2	ns
tpHZ tPLZ	Output Disable Time OE to A or B		1.5	7.5	1.5	10.0	1.5	5.0	1.5	6.0	1.5	4.8	1.5	5.2	ns
tpZH tpZL	Output EnableTime T/R to A or B ⁽³⁾		1.5	9.5	1.5	10.0	1.5	6.2	1.5	6.5	1.5	5.8	1.5	6.2	ns
tpHZ tPLZ	Output Disable Time T/R to A or B ⁽³⁾		1.5	7.5	1.5	10.0	1.5	5.0	1.5	6.0	1.5	4.8	1.5	5.2	ns

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SWITCHING CHARACTERISTICS OVER OPERATING RANGE FOR FCT640/A/C

Symbol	Parameter	Condition ⁽¹⁾	54/74FCT640				54/74FCT640A				54/74FCT640C				Unit
			Com'l.		Mil.		Com'l.		Mil.		Com'l.		Mil.		
			Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	
tPLH tPHL	Propagation Delay A to B, B to A	CL = 50 pF RL = 500Ω	2.0	7.0	2.0	8.0	1.5	5.0	1.5	5.3	1.5	4.4	1.5	4.7	ns
tpZH tpZL	Output Enable Time OE to A or B		2.0	13.0	2.0	16.0	1.5	6.2	1.5	6.5	1.5	5.8	1.5	6.2	ns
tpHZ tPLZ	Output Disable Time OE to A or B		2.0	10.0	2.0	12.0	1.5	5.0	1.5	6.0	1.5	4.8	1.5	5.2	ns
tpZH tpZL	Output Enable Time T/R to A or B ⁽³⁾		2.0	13.0	2.0	16.0	1.5	6.2	1.5	6.5	1.5	5.8	1.5	6.2	ns
tpHZ tPLZ	Output Disable Time T/R to A or B ⁽³⁾		2.0	10.0	2.0	12.0	1.5	5.0	1.5	6.0	1.5	4.8	1.5	5.2	ns

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SWITCHING CHARACTERISTICS OVER OPERATING RANGE FOR FCT645/A/C

Symbol	Parameter	Condition ⁽¹⁾	54/74FCT645				54/74FCT645A				54/74FCT645C				Unit
			Com'l.		Mil.		Com'l.		Mil.		Com'l.		Mil.		
			Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	Min. ⁽²⁾	Max.	
tPLH tPHL	Propagation Delay A to B, B to A	CL = 50 pF RL = 500Ω	1.5	9.5	1.5	11.0	1.5	4.6	1.5	4.9	1.5	4.1	1.5	4.5	ns
tpZH tpZL	Output Enable Time OE to A or B		1.5	11.0	1.5	12.0	1.5	6.2	1.5	6.5	1.5	5.8	1.5	6.2	ns
tpHZ tPLZ	Output Disable Time OE to A or B		1.5	12.0	1.5	13.0	1.5	5.0	1.5	6.0	1.5	4.8	1.5	5.2	ns
tpZH tpZL	Output Enable Time T/R to A or B ⁽³⁾		1.5	11.0	1.5	12.0	1.5	6.2	1.5	6.5	1.5	5.8	1.5	6.2	ns
tpHZ tPLZ	Output Disable Time T/R to A or B ⁽³⁾		1.5	12.0	1.5	13.0	1.5	5.0	1.5	6.0	1.5	4.8	1.5	5.2	ns

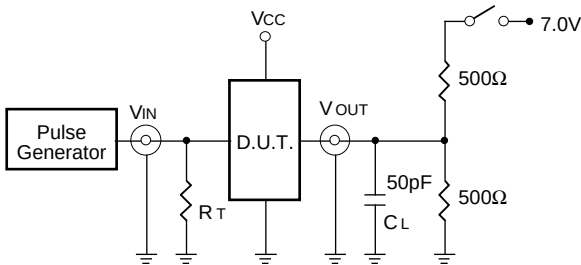
NOTES:

1. See test circuit and waveforms.
2. Minimum limits are guaranteed but not tested on Propagation Delays.
3. This parameter is guaranteed but not tested.

2534 tbl 09

TEST CIRCUITS AND WAVEFORMS

TEST CIRCUITS FOR ALL OUTPUTS



SWITCH POSITION

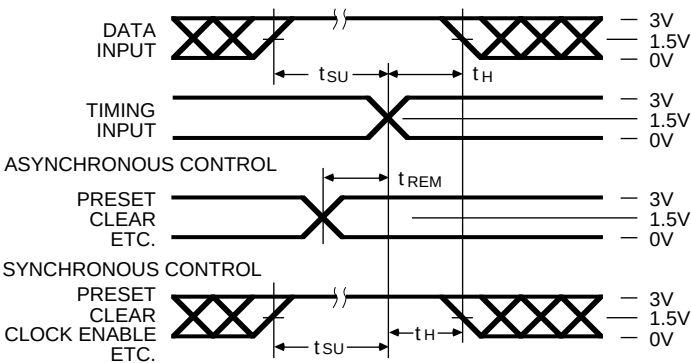
Test	Switch
Open Drain Disable Low Enable Low	Closed
All Other Tests	Open

DEFINITIONS:

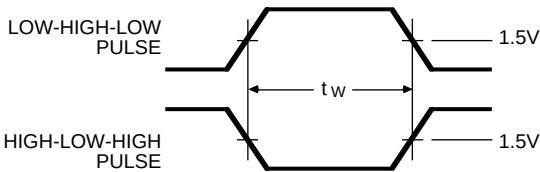
CL = Load capacitance: includes jig and probe capacitance.
RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.

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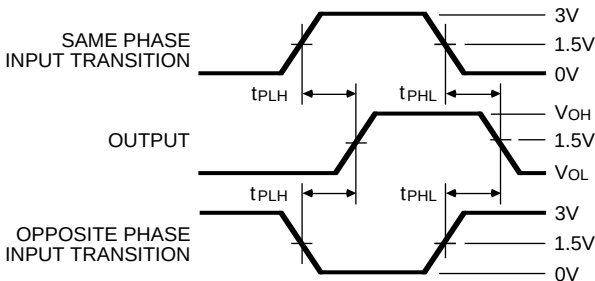
SET-UP, HOLD AND RELEASE TIMES



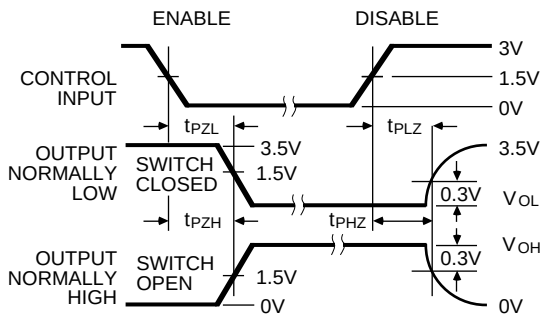
PULSE WIDTH



PROPAGATION DELAY



ENABLE AND DISABLE TIMES



NOTES

- Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
- Pulse Generator for All Pulses: Rate ≤ 1.0 MHz; Zo ≤ 50Ω; tr ≤ 2.5ns; tr ≤ 2.5ns.

2534 drw 04

ORDERING INFORMATION

